

<b>PCN Number:</b>	20190815000	<b>PCN Date:</b>	Oct. 16, 2019
<b>Title:</b>	Datasheet for TLV733P-Q1		
<b>Customer Contact:</b>	PCN Manager	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**TLV733P-Q1**

SBVS283E – AUGUST 2016 – REVISED JULY 2019

#### Changes from Revision D (December 2018) to Revision E

**Page**

- |                                                                                                                                 |    |
|---------------------------------------------------------------------------------------------------------------------------------|----|
| • Changed description of EN pin in <i>Pin Functions</i> table .....                                                             | 4  |
| • Deleted typical specifications from $V_{EN(HI)}$ and $V_{EN(LO)}$ parameters in <i>Electrical Characteristics</i> table ..... | 6  |
| • Added maximum specification to $I_{LIM}$ parameter in <i>Electrical Characteristics</i> table .....                           | 6  |
| • Added <i>and Output Enable</i> to title and changed first paragraph of <i>Shutdown and Output Enable</i> section .....        | 12 |

The datasheet number will be changing.

Device Family	Change From:	Change To:
TLV733P-Q1	SBVS283D	SBVS283E

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TLV733P-Q1>

#### Reason for Change:

To accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

TLV73310PQDBVRQ1	TLV73310PQDBVRQ1	TLV73310PQDBVRQ1	TLV73310PQDBVRQ1
TLV73310PQDRVRQ1	TLV73312PQDRVRQ1	TLV73318PQDRVRQ1	TLV73328PQDRVRQ1
TLV73311PQDBVRQ1	TLV73315PQDBVRQ1	TLV73325PQDBVRQ1	TLV73330PQDBVRQ1
TLV73311PQDRVRQ1	TLV73315PQDRVRQ1	TLV73325PQDRVRQ1	TLV73333PQDBVRQ1
TLV73333PQDRVRQ1			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
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